

IN THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

1-5. (canceled).

6. (previously presented) A method of manufacturing a light-emitting device, comprising :
discharging liquid comprising an organic light-emitting material to a pixel column over a substrate from a nozzle by contacting a contact element attached to the nozzle to a bank so that the nozzle and the pixel column are connected through the liquid comprising said organic light-emitting material.

7. (previously presented) A method of manufacturing a light-emitting device according to claim 6, wherein said nozzle has a large internal diameter portion and a small internal diameter portion .

8-18. (canceled)

19. (previously presented) A method of manufacturing a light-emitting device according to claim 6, further comprising forming a pixel electrode over the substrate .

20-25. (canceled)

26. (previously presented) A method of manufacturing a light-emitting device according to claim 6, further comprising:

forming a thin film transistor over the substrate;

forming an insulating film over said thin film transistor.

27-30. (canceled)

31. (previously presented) A method of manufacturing a light-emitting device according to claim 6,

wherein said liquid comprising said organic light-emitting material is discharged with scanning the nozzle along a direction parallel to the pixel column .

32-47. (canceled).

48. (previously presented) A method of manufacturing a light-emitting device according to claim 6, wherein ultrasonic oscillation is applied to the liquid comprising the organic light-emitting material when the liquid is discharged from the nozzle.

49. (previously presented) A method of manufacturing a light-emitting device according to claim 6, wherein the liquid comprising the organic light-emitting material is heated when the liquid is discharged from the nozzle.

50. (previously presented) A method manufacturing a light-emitting device according to claim 6, wherein the bank comprises a resin material.

51. (previously presented) A method manufacturing a light-emitting device according to claim 19, wherein the bank covers an edge portion of the pixel electrode.

52. (new) A method manufacturing a light-emitting device according to claim 6, wherein the liquid comprising said organic light-emitting material is discharged through the contact element.